

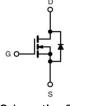
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## **N-channel Power MOSFET**

# $\begin{tabular}{|c|c|c|c|} \hline PRODUCT SUMMARY \\ \hline V_{DS} (V) at T_J max. & 700 \\ \hline R_{DS(on)} max. at 25^{\circ}C (\Omega) & V_{GS} = 10V & 1.3 \\ \hline \end{tabular}$

| Q <sub>g</sub> max. (nC) | 42     |
|--------------------------|--------|
| Q <sub>gs</sub> (nC)     | 6      |
| Q <sub>gd</sub> (nC)     | 12     |
| Configuration            | single |





#### TO-220F

Schematic diagram

#### Features

- ID=7A(Vgs=10V)
- Ultra Low Gate Charge
- Improved dv/dt Capability
- 100% Avalanche Tested
- RoHS compliant

#### Applications

- Switching Mode Power Supplies (SMPS)
- PWM Motor Controls
- DC to DC Converters
- LED Lighting
- Bridge Circuits

| ORDERINGINFORMATION |          |  |  |  |
|---------------------|----------|--|--|--|
| Device              | SPC7N65G |  |  |  |
| Device Package      | TO-220F  |  |  |  |
| Marking             | 7N65G    |  |  |  |

| <b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25^{\circ}C$ , unless otherwise noted) |                                   |                    |      |  |  |
|---|-----------------------------------|--------------------|------|--|--|
| Parameter   | Symbol                            | Limit              | Unit |  |  |
| Drain to Source Voltage   | V <sub>DSS</sub>                  | 650                | V    |  |  |
| Continuous Drain Current (@Tc=25°C)   |                                   | 7 (1)              | A    |  |  |
| Continuous Drain Current (@Tc=100°C)  |                                   | 4.5 <sup>(1)</sup> | А    |  |  |
| Drain current pulsed <sup>(2)</sup>   | I <sub>DM</sub>                   | 28 (1)             | А    |  |  |
| Gate to Source Voltage  | V <sub>GS</sub>                   | 30                 | V    |  |  |
| Single pulsed Avalanche Energy <sup>(3)</sup>                                   | E <sub>AS</sub>                   | 367                | mJ   |  |  |
| Peak diode Recovery dv/dt <sup>(4)</sup>  | dv/dt                             | 6                  | V/ns |  |  |
| Total power dissipation ( $@T_c=25^{\circ}C$ )                                  |                                   | 27                 | W    |  |  |
| Derating Factor above 25°C  | P <sub>D</sub>                    | 0.22               | W/ºC |  |  |
| Operating Junction Temperature & Storage Temperature                            | T <sub>STG</sub> , T <sub>J</sub> | -55 to + 150       | °C   |  |  |
| Maximum lead temperature for soldering purpose                                  | TL                                | 260                | °C   |  |  |
| Mounting torque <sup>(5)</sup>  |                                   | 0.4~0.6            | N.m  |  |  |

#### Notes

- 1. Drain current is limited by maximum junction temperature.
- 2. Repetitive rating : pulse width limited by junction temperature.
- 3. L = 15mH, I<sub>AS</sub> = 7A, V<sub>DD</sub> = 50V, R<sub>G</sub>=25 $\Omega$ , Starting at T<sub>J</sub> = 25°C
- 4.  $I_{SD} \le 7A$ , di/dt = 100A/us,  $V_{DD} \le BV_{DSS}$ , Starting at  $T_J = 25^{\circ}C$

 Mounting consideration for TO220 Fullpack: M3 screw plus flat washer is suggested, free of burr between devices and contact area, the devices are to be mounted to a hole not larger than 3.6mm in contact diameter (chamfer included).



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| THERMAL CHARACTERISTICS                 |                   |       |      |  |  |
|---|-------------------|-------|------|--|--|
| Parameter                               | Symbol            | Value | Unit |  |  |
| Thermal resistance, Junction to case    | R <sub>thjc</sub> | 4.6   | °C/W |  |  |
| Thermal resistance, Junction to ambient | R <sub>thja</sub> | 48    | °C/W |  |  |

| ELECTRICAL CHARACTERISTICS (Tc = 25°C unless otherwise specified) |                             |   |      |      |      |      |  |
|---|-----------------------------|---|------|------|------|------|--|
| Parameter   | Symbol                      | Test conditions   | Min. | Тур. | Max. | Unit |  |
| Off Characteristics   |                             |   |      |      |      |      |  |
| Drain to source breakdown voltage                                 | BV <sub>DSS</sub>           | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA                      | 650  |      |      | V    |  |
| Breakdown voltage temperature coefficient                         | ΔBV <sub>DSS</sub> /<br>ΔTJ | I <sub>D</sub> =250uA, referenced to 25°C                       |      | 0.51 |      | V/ºC |  |
| Drain to source leakage current                                   | I <sub>DSS</sub>            | V <sub>DS</sub> =650V, V <sub>GS</sub> =0V                      |      |      | 1    | uA   |  |
|   |                             | V <sub>DS</sub> =520V, T <sub>C</sub> =125°C                    |      |      | 50   | uA   |  |
| Gate to source leakage current, forward                           | lasa                        | V <sub>GS</sub> =30V, V <sub>DS</sub> =0V                       |      |      | 100  | nA   |  |
| Gate to source leakage current, reverse                           | I <sub>GSS</sub>            | V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V                      |      |      | -100 | nA   |  |
| On Characteristics  |                             |   |      |      |      |      |  |
| Gate threshold voltage  | V <sub>GS(TH)</sub>         | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA        | 2    |      | 4    | V    |  |
| Drain to source on state resistance                               | R <sub>DS(ON)</sub>         | V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A                      |      | 1.05 | 1.3  | Ω    |  |
| Forward Transconductance  | Gfs                         | V <sub>DS</sub> = 30 V, I <sub>D</sub> = 3.5 A                  |      | 5.2  |      | S    |  |
| Dynamic Characteristics   |                             | · · · · · ·   |      |      |      |      |  |
| Input capacitance   | Ciss                        | V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz               |      | 1100 |      | pF   |  |
| Output capacitance  | Coss                        |   |      | 110  |      |      |  |
| Reverse transfer capacitance                                      | C <sub>rss</sub>            |   |      | 15   |      |      |  |
| Turn on delay time  | t <sub>d(on)</sub>          |   |      | 17   |      |      |  |
| Rising time   | tr                          | $V_{DS}$ =380V, $I_{D}$ =7A , $R_{G}$ =25 $\Omega$ -            |      | 33   |      | 20   |  |
| Turn off delay time   | t <sub>d(off)</sub>         |   |      | 82   |      | ns   |  |
| Falltime  | t <sub>f</sub>              |   |      | 41   |      |      |  |
| Total gate charge   | Qg                          |   |      | 37   |      |      |  |
| Gate-source charge  | Q <sub>gs</sub>             | V <sub>DS</sub> =520V, V <sub>GS</sub> =10V, I <sub>D</sub> =7A |      | 6    |      | nC   |  |
| Gate-drain charge   | Q <sub>gd</sub>             |   |      | 12   |      |      |  |

| SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS |                 |   |      |      |      |      |
|---|-----------------|---|------|------|------|------|
| Parameter                                     | Symbol          | Test conditions   | Min. | Тур. | Max. | Unit |
| Continuous source current                     | ls              | Integral reverse p-n Junction _<br>diode in the MOSFET                  |      |      | 7    | А    |
| Pulsed source current                         | I <sub>SM</sub> |   |      |      | 28   | А    |
| Diode forward voltage drop.                   | V <sub>SD</sub> | I <sub>S</sub> =7A, V <sub>GS</sub> =0V                                 |      |      | 1.2  | V    |
| Reverse recovery time                         | T <sub>rr</sub> | I <sub>S</sub> =7A, V <sub>GS</sub> =0V,<br>dI <sub>F</sub> /dt=100A/us |      | 450  |      | ns   |
| Reverse recovery Charge                       | Qrr             |   |      | 9.1  |      | uC   |

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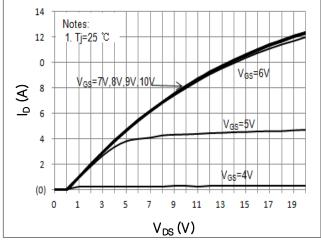
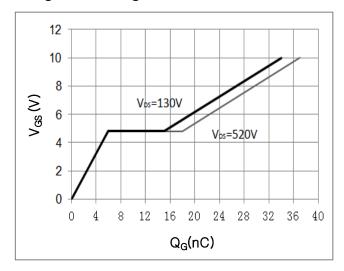
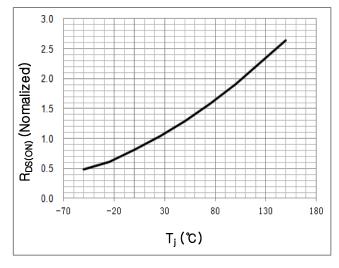


Fig1. Output characteristics

Fig3. Gate charge characteristics







1.4 1.3 1.2 V<sub>GS</sub>=10V R<sub>DS(ON)</sub> (Ω) V<sub>GS</sub>=20V 1.1 1.0 0.9 0.8 4 5 6 7 8 9 10 11 12 13 14 15 16 17 1 2 3  $I_D(A)$ 

Fig2. Drain-source on-state resistance

Fig 4. Capacitance Characteristics

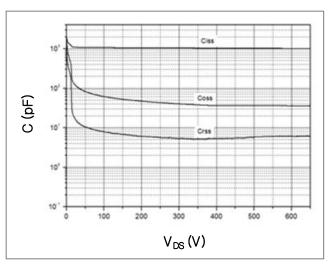
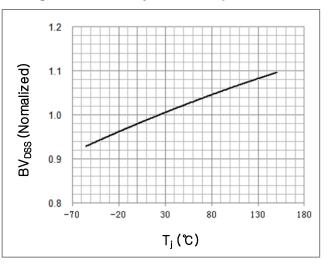


Fig 6. BVDss vs junction temperature



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Fig 7. Safe operating area

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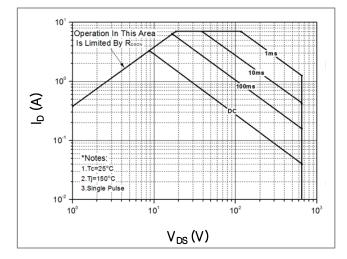


Fig 9. Forward characteristics of reverse diode

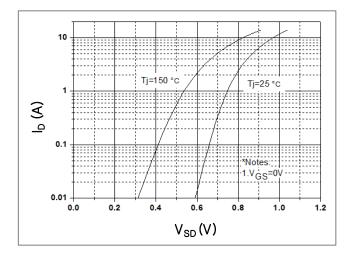
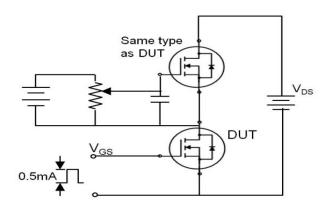
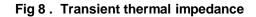
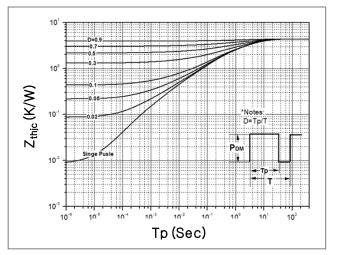


Fig 10. Gate charge test circuit & waveform



V<sub>GS</sub> Q<sub>G</sub> 10V Q<sub>GS</sub> Q<sub>GD</sub> Charge nC





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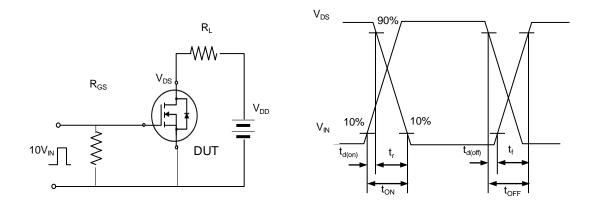
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#### Fig 11. Switching time test circuit & waveform



#### Fig 12. Unclamped Inductive switching test circuit & waveform

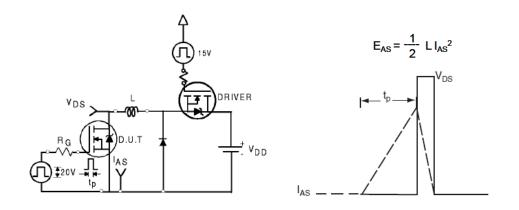
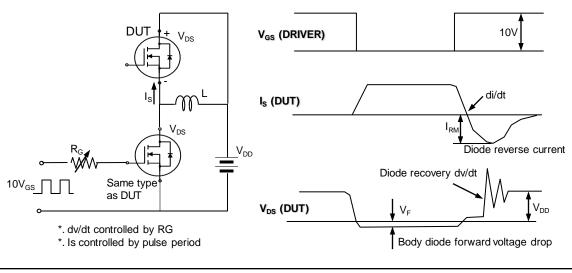


Fig 13. Peak diode recovery dv/dt test circuit & waveform



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